

Diode

Silicon Carbide Schottky Diode

IDH16G120C5

5th Generation CoolSiC™ 1200 V SiC Schottky Diode

Final Datasheet

Rev. 2.2 2021-03-01

Industrial Power Control



CoolSiC[™] SiC Schottky Diode

Features:

- Revolutionary semiconductor material Silicon Carbide
- No reverse recovery current / No forward recovery
- Temperature independent switching behavior
- Low forward voltage even at high operating temperature
- Tight forward voltage distribution
- Excellent thermal performance
- Extended surge current capability
- Specified dv/dt ruggedness
- Qualified according to JEDEC¹⁾ for target applications
- Pb-free lead plating; RoHS compliant

Benefits

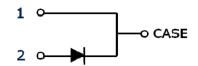
- System efficiency improvement over Si diodes
- Enabling higher frequency / increased power density solutions
- System size / cost savings due to reduced heatsink requirements and smaller magnetics
- Reduced EMI
- Highest efficiency across the entire load range
- Robust diode operation during surge events
- High reliability
- RelatedLinks: www.infineon.com/sic

Applications

- Solar inverters
- Uninterruptable power supplies
- Motor drives
- Power Factor Correction

Package pin definitions

- Pin 1 and backside cathode
- Pin 2 anode













Key Performance and Package Parameters

Туре	V _{DC}	I F	Q _C	$ all_{ extsf{j,max}}$	Marking	Package
IDH16G120C5	1200V	16A	57nC	175°C	D1612C5	PG-TO220-2-1

1) J-STD20 and JESD22





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Maximum ratings

Parameter	Symbol	Value	Unit	
Repetitive peak reverse voltage	V _{RRM}	1200	V	
Continues forward current for $R_{th(j-c,max)}$ $T_C = 145^{\circ}C$, D=1 $T_C = 135^{\circ}C$, D=1 $T_C = 25^{\circ}C$, D=1	I _F	16 19 40	А	
Surge non-repetitive forward current, sine halfwave $T_{\rm C}$ =25°C, t _p =10ms $T_{\rm C}$ =150°C, t _p =10ms	<i>I</i> F,SM	140 120	А	
Non-repetitive peak forward current $T_C = 25^{\circ}C$, $t_P=10 \mu s$	I _{F,max}	850	А	
i²t value $T_C = 25$ °C, $t_p=10$ ms $T_C = 150$ °C, $t_p=10$ ms	∫ i²dt	99 71	A²s	
Diode dv/dt ruggedness $V_R=0960V$	dv/dt	150	V/ns	
Power dissipation T _C = 25°C	P _{tot}	250	W	
Operating and storage temperature	T _j ;T _{stg}	-55175	°C	
Soldering temperature, wavesoldering only allowed at leads, 1.6mm (0.063 in.) from case for 10 s	$T_{ m sold}$	260	°C	
Mounting torque M3 and M4 screws	М	0.7	Nm	

Thermal Resistances

Parameter	Cumbal	Conditions		Value		I Init
rarameter	Symbol	Conditions	min.	typ.	max.	Unit
Characteristic						
Diode thermal resistance, junction – case	R _{th(j-c)}		-	0.46	0.60	K/W
Thermal resistance, junction – ambient	R _{th(j-a)}	leaded	-	-	62	K/W



Electrical Characteristics

Static Characteristics, at T_j=25°C, unless otherwise specified

Parameter	Symbol	Conditions min.	Value	I Init		
rarameter			min.	typ.	max.	Unit
Static Characteristic						
DC blocking voltage	V _{DC}	<i>T</i> _j = 25°C	1200	-	-	V
Diada farward valtage	1/-	<i>I</i> _F = 16A, <i>T</i> _j =25°C	-	1.65	1.95	V
Diode forward voltage	V _F	<i>I</i> _F = 16A, <i>T</i> _j =150°C	-	2.25	2.85	
Reverse current		V _R =1200V, T _j =25°C		5.5	80	μА
	/ R	V _R =1200V, T _j =150°C		28	410	

Dynamic Characteristics, at T_j=25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
r ai ailietei	Syllibol		min.	typ.	max.	Oilit
Dynamic Characteristics						
Total capacitive charge		V _R =800V, T _j =150°C				
	Qc	$Q_C = \int_C^{V_R} C(V) dV$	-	57	-	nC
		0				
		V _R =1 V, <i>f</i> =1 MHz	-	730	-	
Total Capacitance	С	<i>V</i> _R =400 V, <i>f</i> =1 MHz	-	52	-	pF
		V _R =800 V, <i>f</i> =1 MHz	-	40	-	



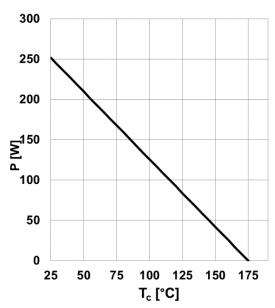


Figure 1. Power dissipation as a function of case temperature, $P_{tot}=f(T_C, R_{th(i-c),max})$

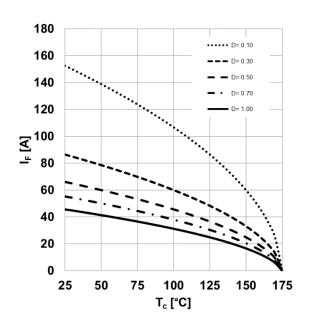


Figure 2. Diode forward current as function of temperature, $T_j \le 175$ °C, $R_{\text{th(j-c),max}}$, parameter D=duty cycle, V_{th} , R_{diff} @ $T_j = 175$ °C

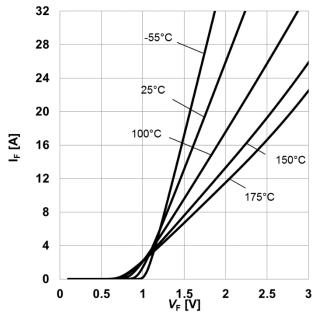


Figure 3. **Typical forward characteristics**, $I_F = f(V_F)$, $t_p = 10 \mu s$, parameter: T_j

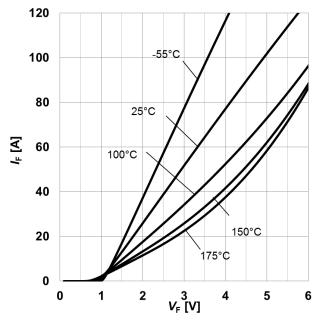


Figure 4. Typical forward characteristics in surge current, $I_F=f(V_F)$, $t_p=10~\mu s$, parameter: T_j



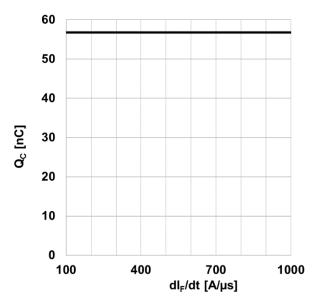


Figure 5. **Typical capacitive charge as function of current slope**¹, $Q_C=f(dI_F/dt)$, $T_j=150^{\circ}C$ 1) Only capacitive charge, guaranteed by design.

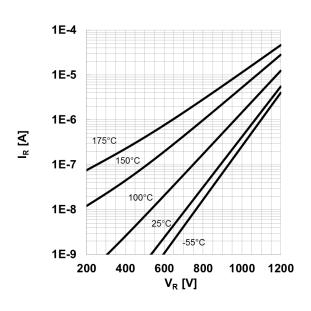


Figure 6. Typical reverse current as function of reverse voltage, $I_R=f(V_R)$, parameter: T_j

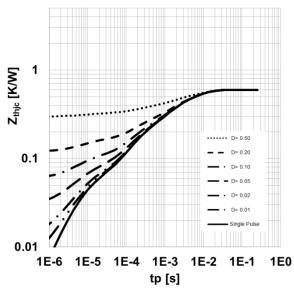


Figure 7. **Max. transient thermal impedance,** $Z_{\text{th,jc}} = f(t_P)$, parameter: $D = t_P/T$

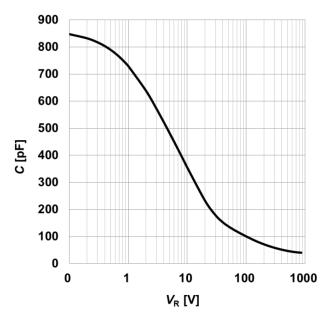


Figure 8. **Typical capacitance as function of** reverse voltage, $C=f(V_R)$; $T_j=25^{\circ}C$; f=1 MHz



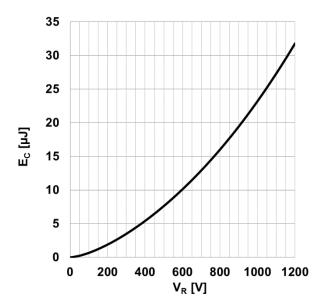
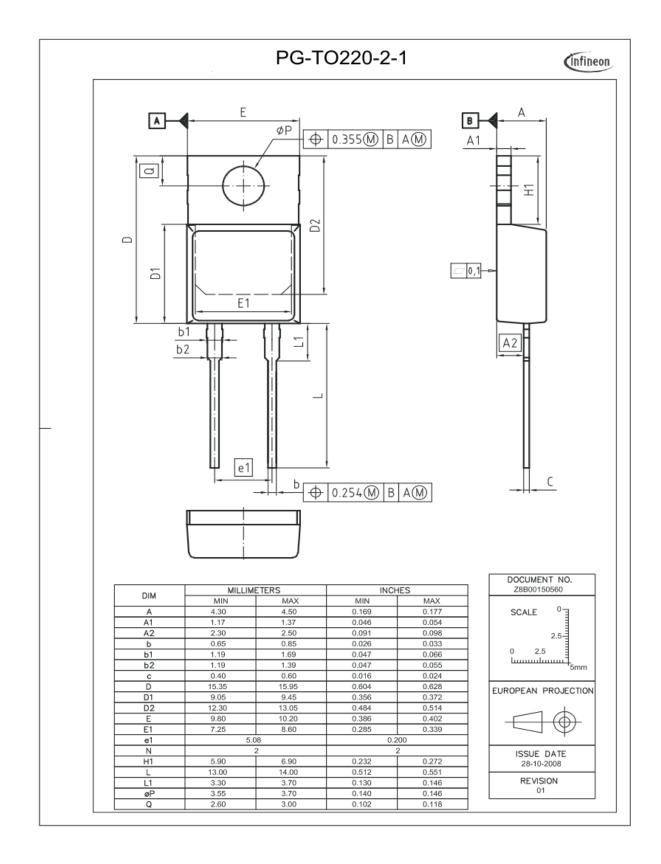


Figure 9. **Typical capacitively stored energy as** function of reverse voltage,

$$E_C = \int_0^{V_R} C(V)VdV$$







Revision History

IDH16G120C5

Revision: 2021-03-01, Rev. 2.2

Previous Revision:

1 TOVIOUS TROVISION.						
Revision	Date Subjects (major changes since last version)					
2.0	2015-09-03	Final data sheet				
2.1	2017-07-21	Editorial Changes				
2.2	2021-03-01	Increased dv/dt ruggedness				

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